



PRELIMINARY

CY7C1021

## 64K x 16 Static RAM

### Features

- **High speed**  
—  $t_{AA} = 12 \text{ ns}$
- **CMOS for optimum speed/power**
- **Low active power**  
— 1320 mW (max.)
- **Automatic power-down when deselected**
- **Independent Control of Upper and Lower bits**
- **Available in 44-pin TSOP II and 400-mil SOJ**

### Functional Description

The CY7C1021 is a high-performance CMOS static RAM organized as 65,536 words by 16 bits. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

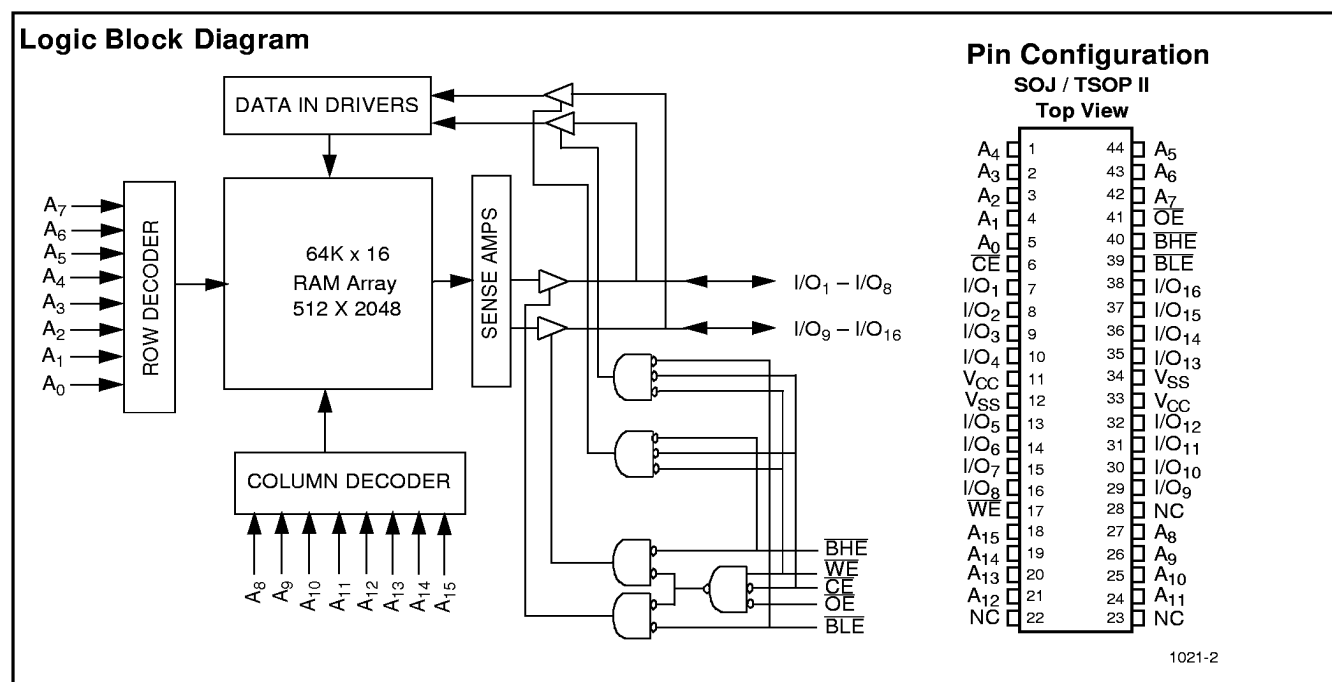
Writing to the device is accomplished by taking chip enable ( $\overline{CE}$ ) and write enable ( $\overline{WE}$ ) inputs LOW. If byte low enable

( $\overline{BLE}$ ) is LOW, then data from I/O pins ( $I/O_1$  through  $I/O_8$ ), is written into the location specified on the address pins ( $A_0$  through  $A_{15}$ ). If byte high enable ( $\overline{BHE}$ ) is LOW, then data from I/O pins ( $I/O_9$  through  $I/O_{16}$ ) is written into the location specified on the address pins ( $A_0$  through  $A_{15}$ ).

Reading from the device is accomplished by taking chip enable ( $\overline{CE}$ ) and output enable ( $\overline{OE}$ ) LOW while forcing the write enable ( $\overline{WE}$ ) HIGH. If byte low enable ( $\overline{BLE}$ ) is LOW, then data from the memory location specified by the address pins will appear on  $I/O_1$  to  $I/O_8$ . If byte high enable ( $\overline{BHE}$ ) is LOW, then data from memory will appear on  $I/O_9$  to  $I/O_{16}$ . See the truth table at the back of this datasheet for a complete description of read and write modes.

The input/output pins ( $I/O_1$  through  $I/O_{16}$ ) are placed in a high-impedance state when the device is deselected ( $\overline{CE}$  HIGH), the outputs are disabled ( $\overline{OE}$  HIGH), the  $\overline{BHE}$  and  $\overline{BLE}$  are disabled ( $\overline{BHE}$ ,  $\overline{BLE}$  HIGH), or during a write operation ( $\overline{CE}$  LOW, and  $\overline{WE}$  LOW).

The CY7C1021 is available in standard 44-pin TSOP Type II and 400-mil-wide SOJ packages.



### Selection Guide

		7C1021-12	7C1021-15	7C1021-20	7C1021-25
Maximum Access Time (ns)		12	15	20	25
Maximum Operating Current (mA)	Commercial	220	240	220	200
Maximum CMOS Standby Current (mA)	Commercial	5	10	10	10

Shaded areas contain advanced information.

**Maximum Ratings**

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -65°C to +150°C

Ambient Temperature with  
Power Applied ..... -55°C to +125°C

Supply Voltage on  $V_{CC}$  to Relative GND<sup>[1]</sup> ..... -0.5V to +7.0V

DC Voltage Applied to Outputs  
in High Z State<sup>[1]</sup> ..... -0.5V to  $V_{CC} + 0.5V$

DC Input Voltage<sup>[1]</sup> ..... -0.5V to  $V_{CC} + 0.5V$

Current into Outputs (LOW) ..... 20 mA

Static Discharge Voltage ..... >2001V  
(per MIL-STD-883, Method 3015)

Latch-Up Current ..... >200 mA

**Operating Range**

Range	Ambient Temperature <sup>[2]</sup>	$V_{CC}$
Commercial	0°C to +70°C	5V ± 10%

**Electrical Characteristics** Over the Operating Range

Parameter	Description	Test Conditions	7C1021-12		7C1021-15		7C1021-20		7C1021-25		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
$V_{OH}$	Output HIGH Voltage	$V_{CC} = \text{Min.},$ $I_{OH} = -4.0 \text{ mA}$	2.4		2.4		2.4		2.4		V
$V_{OL}$	Output LOW Voltage	$V_{CC} = \text{Min.},$ $I_{OL} = 8.0 \text{ mA}$		0.4		0.4		0.4		0.4	V
$V_{IH}$	Input HIGH Voltage		2.2	6.0	2.2	6.0	2.2	6.0	2.2	6.0	V
$V_{IL}$	Input LOW Voltage <sup>[1]</sup>		-0.5	0.8	-0.3	0.8	-0.3	0.8	-0.3	0.8	V
$I_{IX}$	Input Load Current	$GND \leq V_I \leq V_{CC}$	-1	+1	-1	+1	-1	+1	-1	+1	μA
$I_{OZ}$	Output Leakage Current	$GND \leq V_I \leq V_{CC},$ Output Disabled	-1	+1	-5	+5	-5	+5	-5	+5	μA
$I_{OS}$	Output Short Circuit Current <sup>[3]</sup>	$V_{CC} = \text{Max.},$ $V_{OUT} = GND$		-300		-300		-300		-300	mA
$I_{CC}$	$V_{CC}$ Operating Supply Current	$V_{CC} = \text{Max.},$ $I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$		220		240		220		200	mA
$I_{SB1}$	Automatic CE Power-Down Current —TTL Inputs	Max. $V_{CC},$ $\overline{CE} \geq V_{IH}$ $V_{IN} \geq V_{IH}$ or $V_{IN} \leq V_{IL}, f = f_{MAX}$		40		40		40		40	mA
$I_{SB2}$	Automatic CE Power-Down Current —CMOS Inputs	Max. $V_{CC},$ $\overline{CE} \geq V_{CC} - 0.3V,$ $V_{IN} \geq V_{CC} - 0.3V,$ or $V_{IN} \leq 0.3V, f=0$		5		10		10		10	mA

Shaded areas contain advanced information.

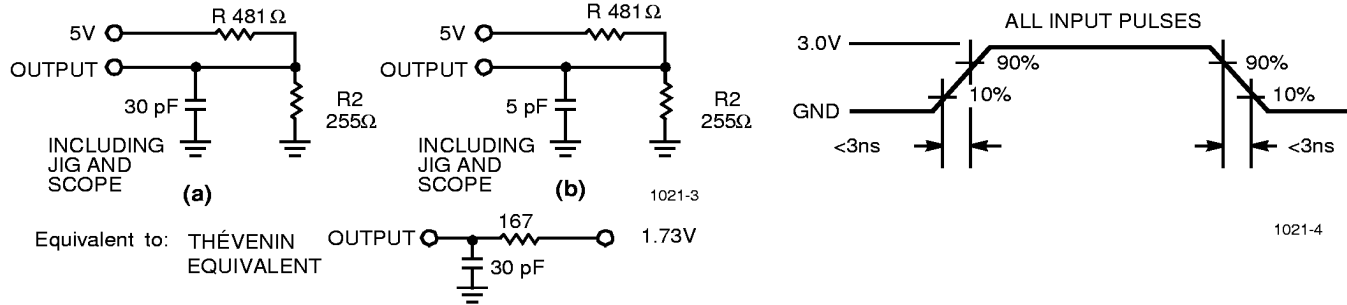
**Capacitance<sup>[4]</sup>**

Parameter	Description	Test Conditions	Max.	Unit
$C_{IN}$	Input Capacitance	$T_A = 25^\circ\text{C}, f = 1 \text{ MHz},$ $V_{CC} = 5.0V$	8	pF
$C_{OUT}$	Output Capacitance		8	pF

**Notes:**

- $V_{IL}(\text{min.}) = -2.0V$  for pulse durations of less than 20 ns.
- $T_A$  is the "instant on" case temperature.
- Not more than one output should be shorted at one time. Duration of the short circuit should not exceed 30 seconds.
- Tested initially and after any design or process changes that may affect these parameters.

## AC Test Loads and Waveforms



## Switching Characteristics<sup>[5]</sup> Over the Operating Range

Parameter	Description	7C1021-12		7C1021-15		7C1021-20		7C1021-25		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
READ CYCLE										
t <sub>RC</sub>	Read Cycle Time	12		15		20		25		ns
t <sub>AA</sub>	Address to Data Valid		12		15		20		25	ns
t <sub>OHA</sub>	Data Hold from Address Change	3		3		3		3		ns
t <sub>ACE</sub>	$\overline{CE}$ LOW to Data Valid		12		15		20		25	ns
t <sub>DOE</sub>	$\overline{OE}$ LOW to Data Valid		6		7		9		11	ns
t <sub>LZOE</sub>	$\overline{OE}$ LOW to Low Z	0		0		0		0		ns
t <sub>HZOE</sub>	$\overline{OE}$ HIGH to High Z <sup>[6, 7]</sup>		6		7		9		11	ns
t <sub>LZCE</sub>	$\overline{CE}$ LOW to Low Z <sup>[7]</sup>	3		3		3		3		ns
t <sub>HZCE</sub>	$\overline{CE}$ HIGH to High Z <sup>[6, 7]</sup>		6		7		9		11	ns
t <sub>PU</sub>	$\overline{CE}$ LOW to Power-Up	0		0		0		0		ns
t <sub>PD</sub>	$\overline{CE}$ HIGH to Power-Down		12		15		20		25	ns
t <sub>DBE</sub>	Byte enable to Data Valid		6		7		9		11	ns
t <sub>LZBE</sub>	Byte enable to Low Z	0		0		0		0		ns
t <sub>HZBE</sub>	Byte disable to High Z		6		7		9		11	ns
WRITE CYCLE <sup>[8]</sup>										
t <sub>WC</sub>	Write Cycle Time	12		15		20		25		ns
t <sub>SCE</sub>	$\overline{CE}$ LOW to Write End	9		10		12		15		ns
t <sub>AW</sub>	Address Set-Up to Write End	8		10		12		15		ns
t <sub>HA</sub>	Address Hold from Write End	0		0		0		0		ns
t <sub>SA</sub>	Address Set-Up to Write Start	0		0		0		0		ns
t <sub>PWE</sub>	$\overline{WE}$ Pulse Width	8		10		12		15		ns
t <sub>SD</sub>	Data Set-Up to Write End	6		8		10		15		ns
t <sub>HD</sub>	Data Hold from Write End	0		0		0		0		ns
t <sub>LZWE</sub>	$\overline{WE}$ HIGH to Low Z <sup>[7]</sup>	3		3		3		3		ns
t <sub>HZWE</sub>	$\overline{WE}$ LOW to High Z <sup>[6, 7]</sup>		6		7		9		11	ns
t <sub>BW</sub>	Byte enable to end of write	8		9		12		14		ns

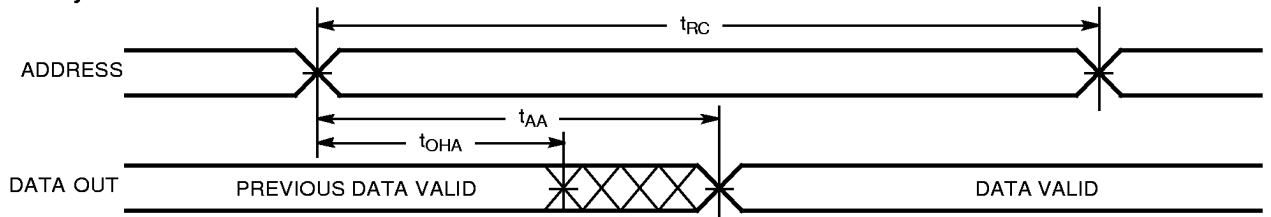
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### Notes:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified  $I_{OL}/I_{OH}$  and 30-pF load capacitance.
- $t_{HZOE}$ ,  $t_{HZBE}$ ,  $t_{HZCE}$ , and  $t_{HZWE}$  are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured  $\pm 500$  mV from steady-state voltage.
- At any given temperature and voltage condition,  $t_{HZCE}$  is less than  $t_{LZCE}$ ,  $t_{HZOE}$  is less than  $t_{LZOE}$ , and  $t_{HZWE}$  is less than  $t_{LZWE}$  for any given device.
- The internal write time of the memory is defined by the overlap of  $\overline{CE}$  LOW,  $\overline{WE}$  LOW and  $\overline{BHE}$  /  $\overline{BLE}$  LOW.  $\overline{CE}$ ,  $\overline{WE}$  and  $\overline{BHE}$  /  $\overline{BLE}$  must be LOW to initiate a write, and the transition of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.

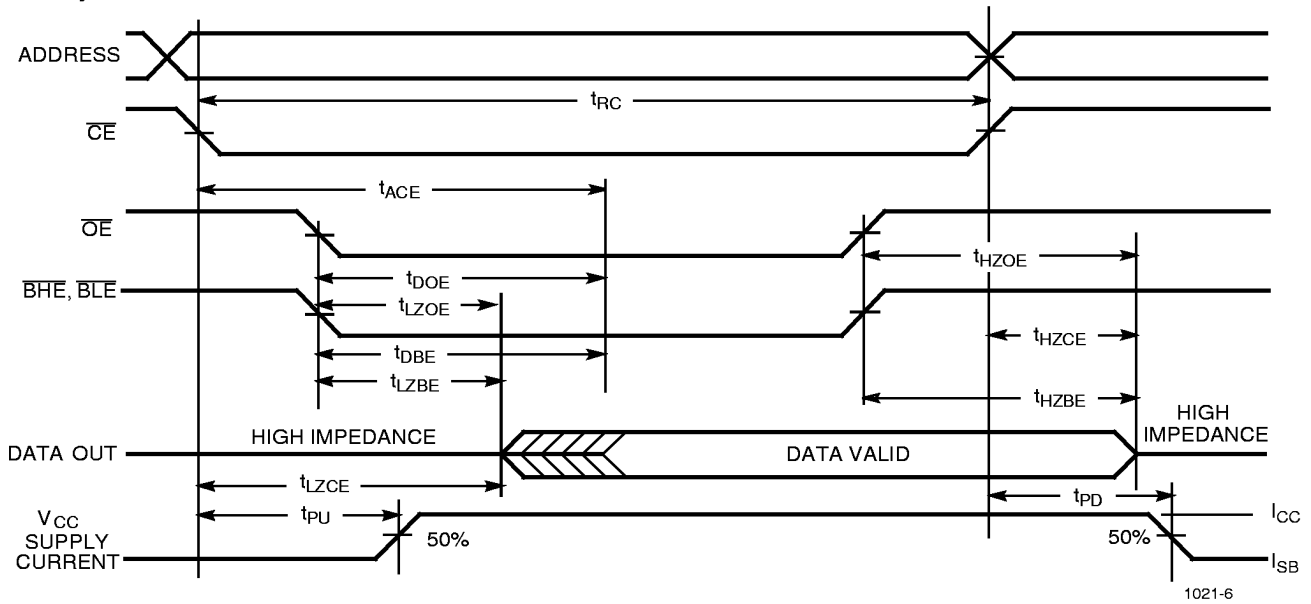
## Switching Waveforms

### Read Cycle No. 1<sup>[9, 10]</sup>



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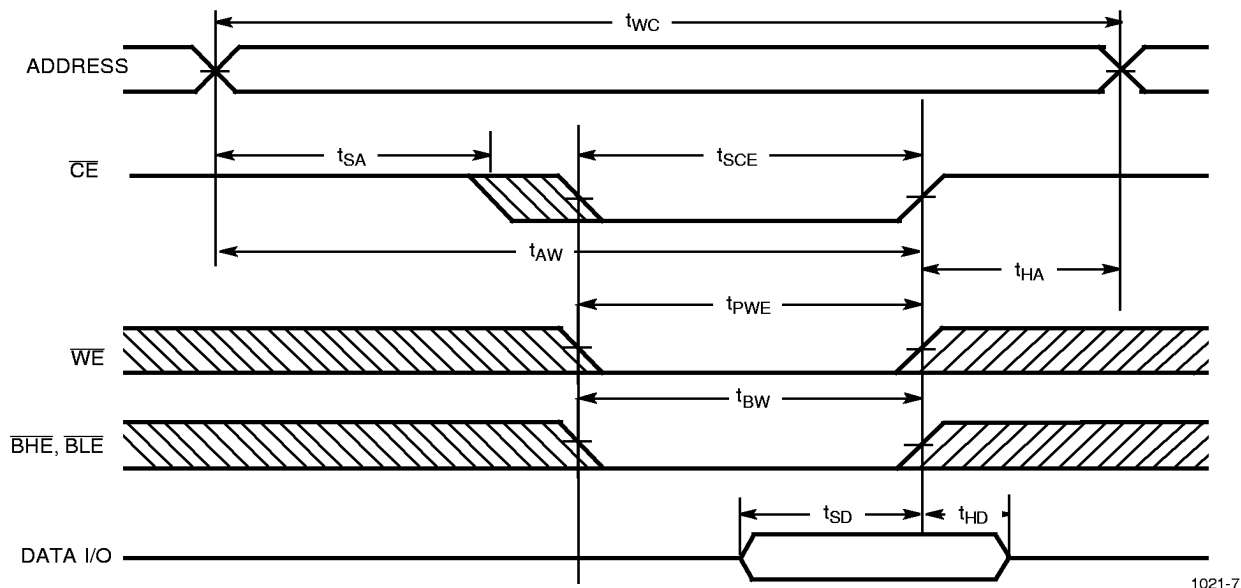
### Read Cycle No. 2 ( $\overline{OE}$ Controlled)<sup>[10, 11]</sup>



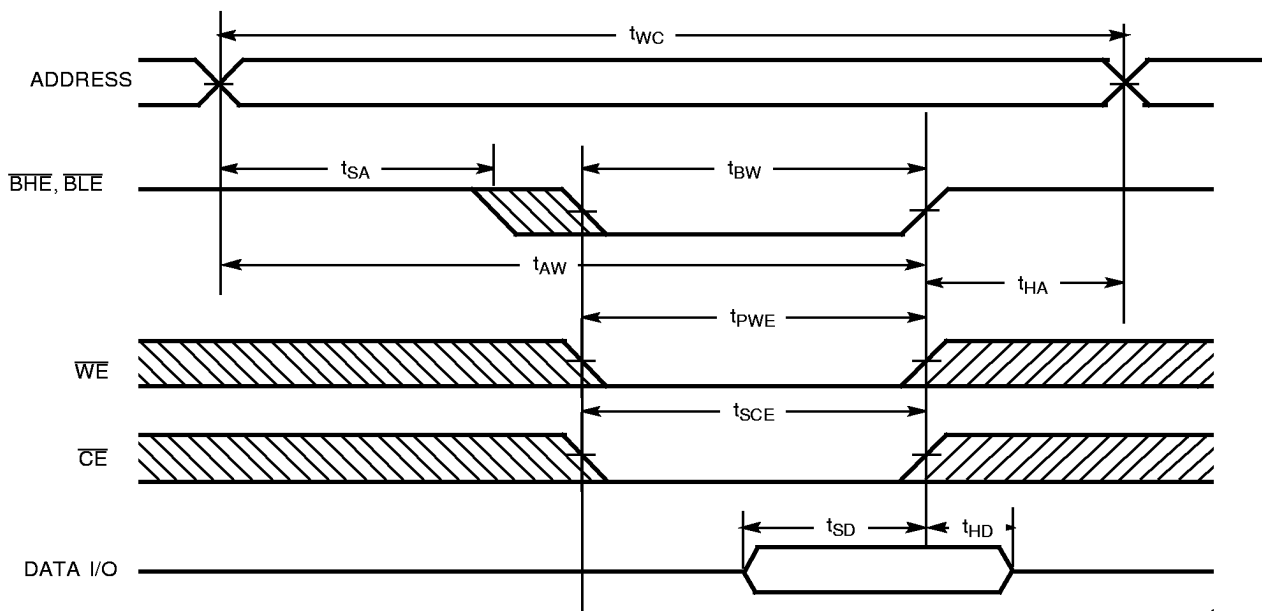
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#### Notes:

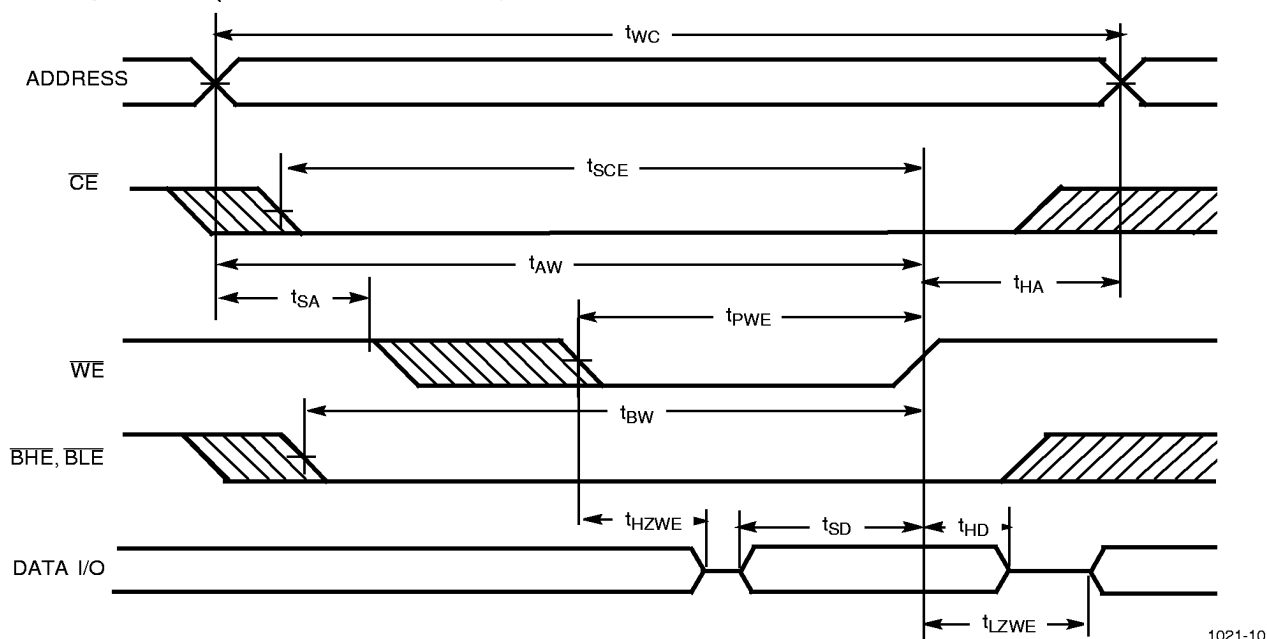
9. Device is continuously selected.  $\overline{OE}$ ,  $\overline{CE}$ , BHE and/or BLE =  $V_{IL}$ .
10. WE is HIGH for read cycle.
11. Address valid prior to or coincident with  $\overline{CE}$  transition LOW.

**Switching Waveforms (continued)**
**Write Cycle No. 1 ( $\overline{\text{CE}}$  Controlled)** <sup>[12, 13]</sup>


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**Write Cycle No. 2 ( $\overline{\text{BLE}}$  or  $\overline{\text{BHE}}$  Controlled)**

**Notes:**

12. Data I/O is high impedance if  $\overline{\text{OE}}$  or  $\overline{\text{BHE}}$  and/or  $\overline{\text{BLE}} = V_{IH}$ .
13. If  $\overline{\text{CE}}$  goes HIGH simultaneously with  $\overline{\text{WE}}$  going HIGH, the output remains in a high-impedance state.

**Switching Waveforms (continued)**
**Write Cycle No.3 (WE Controlled, OE LOW)**


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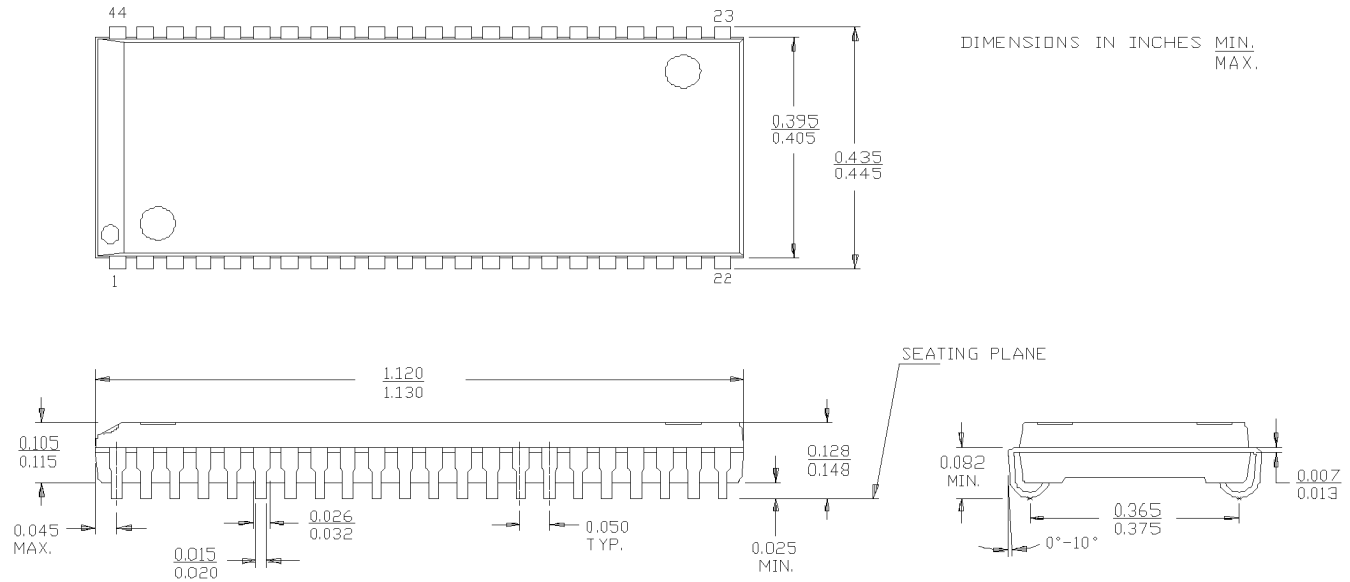
**Truth Table**

CE	OE	WE	BLE	BHE	I/O <sub>1</sub> - I/O <sub>8</sub>	I/O <sub>9</sub> - I/O <sub>16</sub>	Mode	Power
H	X	X	X	X	High Z	High Z	Power-Down	Standby ( $I_{SB}$ )
L	L	H	L	L	Data Out	Data Out	Read - All bits	Active ( $I_{CC}$ )
			L	H	Data Out	High Z	Read - Lower bits only	Active ( $I_{CC}$ )
			H	L	High Z	Data Out	Read - Upper bits only	Active ( $I_{CC}$ )
L	X	L	L	L	Data In	Data In	Write - All bits	Active ( $I_{CC}$ )
			L	H	Data In	High Z	Write - Lower bits only	Active ( $I_{CC}$ )
			H	L	High Z	Data In	Write - Upper bits only	Active ( $I_{CC}$ )
L	H	H	X	X	High Z	High Z	Selected, Outputs Disabled	Active ( $I_{CC}$ )
L	X	X	H	H	High Z	High Z	Selected, Outputs Disabled	Active ( $I_{CC}$ )

**Ordering Information**

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
12	CY7C1021-12VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021-12ZC	Z44	44-Lead TSOP Type II	Commercial
15	CY7C1021-15VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021-15ZC	Z44	44-Lead TSOP Type II	Commercial
20	CY7C1021-20VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021-20ZC	Z44	44-Lead TSOP Type II	Commercial
25	CY7C1021-25VC	V34	44-Lead (400-Mil) Molded SOJ	Commercial
	CY7C1021-25ZC	Z44	44-Lead TSOP Type II	Commercial

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**Package Diagrams**
**44-Lead (400-Mil) Molded SOJ V34**

**44-Pin TSOP II Z44**
